


CERTIFICATE
FOR EUROPEAN PRODUCT SAFETY

Reference No. . SE-S-2200907R1

Connector for Class I equipment for cold condition

Type designation:	ICO-002, ICO-003
Certificate holder:	Ningbo Hongyi Electronics Technology Co., Ltd. Guan Haiwei Industrial Zone East Area, Guan Haiwei Town, Cixi, Ningbo, Zhejiang 315314, China
The product complies with the standard(s):	EN IEC 60320-1: 2021 BS EN IEC 60320-1: 2021
Date of expiry:	22 July, 2027
EU Directive information:	The product listed has been evaluated by a Third Party Body and deemed to meet the listed harmonized standards. This Certificate can be used in support of a claim in meeting relevant EU legislation and mandatory Conformity Marking. And in accordance with EU law, the claim is the sole obligation of the Manufacturer/ Importer.

Additional information in Appendix

Certification Body: Intertek Semko AB, Product Certification **Place:** Shanghai

Signed:


Date: 30 May, 2024


Hyden Li

APPENDIX:

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Technical Data:

Type designation	ICO-002, ICO-003
Rated voltage (V)	250~
Rated current (A)	10
Class	I
IP-Class	20
Type of Cord	H05VV-F
Number of Conductors	3
Conductor area	0,75-1,0mm ² (Max. cord length 2m for 3x0,75mm ²)
Standard sheet	C13 of EN 60320-3:2014
Trademark	

HONGYI

Test Report

220201695SHA-001 A1

Product information

Non-rewirable, connector for Class I equipment for cold conditions.
ICO-002: with longitudinal cord entry;
ICO-003: with lateral cord entry.

Manufacturing Sites:

Ningbo Hongyi Electronics Technology Co., Ltd.
Guan Haiwei Industrial Zone East Area, Guan Haiwei Town, Cixi, Ningbo,
Zhejiang 315314, China

The instruction for use shall be written in a language acceptable according to the national regulation in the country where the product is to be used.

This certificate replaces previously issued ref. No. SE-S-2200907 dated 2022-07-22. A new certificate has been issued on account of adding the BS EN IEC 60320-1:2021 deviation.

Certification Body:

Intertek Semko AB, Product Certification

Place: Shanghai

Signed:

Date: 30 May, 2024


Hyden Li